# **Low Voltage Comparators**

The NCS2200 Series is an industry first sub—one volt, low power comparator family. These devices consume only 10  $\mu A$  of supply current. They are guaranteed to operate at a low voltage of 0.85 V which allows them to be used in systems that require less than 1.0 V and are fully operational up to 6.0 V which makes them convenient for use in both 3.0 V and 5.0 V systems. Additional features include no output phase inversion with overdriven inputs, internal hysteresis, which allows for clean output switching, and rail—to—rail input and output performance. The NCS2200 Series is available in complementary and open drain outputs and a variety of packages. There are two industry standard pinouts for SOT–23–5 and SC70–5 packages. The NCS2200 is also available in the tiny DFN 2x2.2 package. The NCS2200A and NCS2202A are available in UDFN 1.2x1.0 package. See package option information in Table 1 on page 2 for more information.

#### **Features**

- Operating Voltage of 0.85 V to 6.0 V
- Rail-to-Rail Input/Output Performance
- Low Supply Current of 10 μA
- No Phase Inversion with Overdriven Input Signals
- Glitchless Transitioning in or out of Tri-State Mode
- Complementary or Open Drain Output Configuration
- Internal Hysteresis
- Propagation Delay of 1.0 μs for NCS2200
- NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

## **Typical Applications**

- Single Cell NiCd/NiMH Battery Powered Applications
- Automotive

#### **End Products**

- Cellphones, Smart Phones
- Alarm and Security Systems
- Personal Digital Assistants



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SOT-23-5 (TSOP-5) SN SUFFIX CASE 483



DFN 2x2.2 SQL SUFFIX CASE 488



SC70-5 SQ SUFFIX CASE 419A



UDFN 1.2x1.0 MU SUFFIX CASE 517AA

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 13 of this data sheet.

#### **DEVICE MARKING INFORMATION**

See general marking information in the device marking section on page 14 of this data sheet.

**Table 1. COMPARATOR SELECTOR GUIDE** 

Output Type	Device	Package	Pinout Style
Complementary	NCS2200AMUT1G	UDFN, 1.2x1.0	N/A
Complementary	NCS2200SN1T1G	SOT-23-5	1
Complementary	NCV2200SN1T1G*	SOT-23-5	1
Complementary	NCS2200SN2T1G	SOT-23-5	2
Complementary	NCV2200SN2T1G*	SOT-23-5	2
Complementary	NCS2200SQ2T2G	SC70-5	2
Complementary	NCV2200SQ2T2G*	SC70-5	2
Complementary	NCS2200SQLT1G	DFN, 2x2.2	N/A
Open Drain	NCS2202SN1T1G	SOT-23-5	1
Open Drain	NCS2202SN2T1G	SOT-23-5	2
Open Drain	NCV2202SN2T1G*	SOT-23-5	2
Open Drain	NCS2202SQ1T2G	SC70-5	1
Open Drain	NCS2202SQ2T2G	SC70-5	2
Open Drain	NCS2202AMUTBG	UDFN, 1.2 x 1.0	N/A

<sup>\*</sup>NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

#### **PIN CONNECTIONS**



Figure 1. SOT-23-5 (NCS2200, NCS2202), SC70-5 (NCS2200, NCS2202)

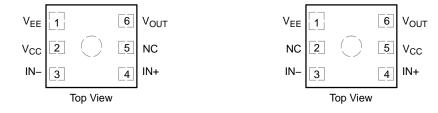


Figure 2. DFN 2x2.2 (NCS2200)

Figure 3. UDFN 1.2x1.0 (NCS2200A/NCS2202A)

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Supply Voltage Range (V <sub>CC</sub> to V <sub>EE</sub> )	V <sub>S</sub>	6.0	V
Non-inverting/Inverting Input to V <sub>EE</sub>	V <sub>CM</sub>	-0.2 to (V <sub>CC</sub> + 0.2)	V
Operating Junction Temperature	TJ	150	°C
Operating Ambient Temperature Range NCS2200, NCS2202, NCS2200A, NCS2202A NCV2200, NCV2202	T <sub>A</sub>	-40 to +105 -40 to +125	°C
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C
Output Short Circuit Duration Time (Note 1)	t <sub>S</sub>	Indefinite	S
ESD Tolerance (Note 2) NCS2200 Human Body Model Machine Model NCS2202 Human Body Model Machine Model NCS2200A Human Body Model Machine Model NCS2202A Human Body Model – all pins except output Human Body Model – output pin Machine Model	ESD HBM MM HBM MM HBM HBM MM	2000 200 2000 2000 1900 200 1500 500 150	V
Thermal Resistance, Junction-to-Ambient TSOP-5 DFN (Note 3) SC70-5 UDFN	$R_{ hetaJA}$	238 215 283 350	°C/W

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The maximum package power dissipation limit must not be exceeded.  $P_D = \frac{TJ(max) - TA}{R_0JA}$ 2. ESD data available upon request.
3. For more information, refer to application note, AND8080/D.

$$P_D = \frac{T_{J(max)} - T_{A}}{R_{\theta JA}}$$

NCS2200 ELECTRICAL CHARACTERISTICS (For all values  $V_{CC}$  = 0.85 V to 6.0 V,  $V_{EE}$  = 0 V,  $T_A$  = 25°C, unless otherwise noted.) (Note 4)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{HYS}$	Input Hysteresis	T <sub>A</sub> = 25°C	2.0	8.0	20	mV
V <sub>IO</sub>	Input Offset Voltage	$V_{CC} = 0.85 \text{ V}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High} \text{ (Note 5)}$	-10 -12	0.5 -	+10 +12	mV
		$V_{CC} = 3.0 \text{ V}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High}$	-6.0 -8.0	0.5 -	+6.0 +8.0	•
		$V_{CC} = 6.0 \text{ V}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High}$	-5.0 -7.0	0.5 -	+5.0 +7.0	
$V_{CM}$	Common Mode Voltage Range		-	V <sub>EE</sub> to V <sub>CC</sub>	-	V
I <sub>LEAK</sub>	Output Leakage Current	V <sub>CC</sub> = 6.0 V	_	3.3	-	nA
I <sub>SC</sub>	Output Short–Circuit Sourcing or Sinking	V <sub>out</sub> = GND	-	70	_	mA
CMRR	Common Mode Rejection Ratio	$V_{CM} = V_{CC}$	53	65	-	dB
I <sub>IB</sub>	Input Bias Current		_	1.0	-	рΑ
PSRR	Power Supply Rejection Ratio	$\Delta V_{S} = 2.575 \text{ V}$	45	55	-	dB
I <sub>CC</sub>	Supply Current	$V_{CC} = 0.85 \text{ V}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High} \text{ (Note 5)}$	-	10 -	15 17	μА
		$V_{CC} = 3.0 \text{ V}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High}$	-	10 -	15 17	
		$V_{CC} = 6.0 \text{ V}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High}$	-	10 -	15 17	
V <sub>OH</sub>	Output Voltage High	$V_{CC} = 0.85 \text{ V}, I_{source} = 0.5 \text{ mA}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High} \text{ (Note 5)}$	V <sub>CC</sub> - 0.2 V <sub>CC</sub> - 0.225	V <sub>CC</sub> - 0.10	-	V
		$V_{CC} = 3.0 \text{ V, } I_{source} = 3.0 \text{ mA}$ $T_{A} = 25^{\circ}\text{C}$ $T_{A} = T_{Low} \text{ to } T_{High}$	V <sub>CC</sub> - 0.2 V <sub>CC</sub> - 0.25	V <sub>CC</sub> - 0.12	-	
		$V_{CC}$ = 6.0 V, $I_{source}$ = 5.0 mA $T_A$ = 25°C $T_A$ = $T_{Low}$ to $T_{High}$	V <sub>CC</sub> - 0.2 V <sub>CC</sub> - 0.25	V <sub>CC</sub> - 0.12	-	
V <sub>OL</sub>	Output Voltage Low	$V_{CC} = 0.85 \text{ V, } I_{sink} = 0.5 \text{ mA}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High} \text{ (Note 5)}$	-	V <sub>EE</sub> + 0.10	V <sub>EE</sub> + 0.2 V <sub>EE</sub> + 0.225	V
		$V_{CC}$ = 3.0 V, $I_{sink}$ = 3.0 mA $T_A$ = 25°C $T_A$ = $T_{Low}$ to $T_{High}$	-	V <sub>EE</sub> + 0.12	V <sub>EE</sub> + 0.2 V <sub>EE</sub> + 0.25	
		$V_{CC}$ = 6.0 V, $I_{sink}$ = 5.0 mA $T_A$ = 25°C $T_A$ = $T_{Low}$ to $T_{High}$	-	V <sub>EE</sub> + 0.12	V <sub>EE</sub> + 0.2 V <sub>EE</sub> + 0.25	
t <sub>PHL</sub>	Propagation Delay, High-to-Low	20 mV Overdrive, C <sub>L</sub> = 15 pF	-	1080	-	ns
t <sub>PLH</sub>	Propagation Delay, Low-to-High	20 mV Overdrive, C <sub>L</sub> = 15 pF	-	900	-	ns
t <sub>FALL</sub>	Output Fall Time	$V_{CC} = 6.0 \text{ V}, C_L = 50 \text{ pF}$	-	13	_	ns
t <sub>RISE</sub>	Output Rise Time	$V_{CC} = 6.0 \text{ V}, C_L = 50 \text{ pF}$	-	8.0	-	ns
t <sub>PU</sub>	Powerup Time		_	35	_	μS

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. The limits over the extended temperature range are guaranteed by design only.

5. NCS2200: T<sub>Low</sub> = -40°C, T<sub>High</sub> = +105°C; NCV2200: T<sub>Low</sub> = -40°C, T<sub>High</sub> = +125°C

NCS2202 ELECTRICAL CHARACTERISTICS (For all values  $V_{CC}$  = 0.85 V to 6.0 V,  $V_{EE}$  = 0 V,  $T_A$  = 25°C,  $R_{pullup}$  = 10 k $\Omega$ , unless otherwise noted.) (Note 6)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{HYS}$	Input Hysteresis	T <sub>A</sub> = 25°C	2.0	8.0	20	mV
V <sub>IO</sub>	Input Offset Voltage	$V_{CC} = 0.85 \text{ V}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High} \text{ (Note 7)}$	-10 -12	0.5 -	+10 +12	mV
		$V_{CC} = 3.0 \text{ V}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High}$	-6.0 -8.0	0.5 -	+6.0 +8.0	
		$V_{CC} = 6.0 \text{ V}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High}$	-5.0 -7.0	0.5 -	+5.0 +7.0	
$V_{CM}$	Common Mode Voltage Range		_	V <sub>EE</sub> to V <sub>CC</sub>	_	V
$I_{LEAK}$	Output Leakage Current	V <sub>CC</sub> = 6.0 V	_	3.3	_	nA
I <sub>SC</sub>	Output Short–Circuit Sourcing or Sinking	V <sub>out</sub> = GND	_	70	-	mA
CMRR	Common Mode Rejection Ratio	V <sub>CM</sub> = V <sub>CC</sub>	53	65	-	dB
I <sub>IB</sub>	Input Bias Current		-	1.0	_	pА
PSRR	Power Supply Rejection Ratio	$\Delta V_{S} = 2.575 \text{ V}$	45	55	_	dB
I <sub>CC</sub>	Supply Current	$V_{CC} = 0.85 \text{ V}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High} \text{ (Note 7)}$	-	10 –	15 17	μΑ
		$V_{CC} = 3.0 \text{ V}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High}$	-	10 –	15 17	
		$V_{CC} = 6.0 \text{ V}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High}$	-	10 -	15 17	
V <sub>OL</sub>	Output Voltage Low	$V_{CC} = 0.85 \text{ V, } I_{sink} = 0.5 \text{ mA}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High} \text{ (Note 7)}$	-	V <sub>EE</sub> + 0.10	V <sub>EE</sub> + 0.2 V <sub>EE</sub> + 0.225	V
		$\begin{split} V_{CC} &= 3.0 \text{ V, I}_{sink} = 3.0 \text{ mA} \\ T_{A} &= 25^{\circ}\text{C} \\ T_{A} &= T_{Low} \text{ to T}_{High} \end{split}$	-	V <sub>EE</sub> + 0.12	V <sub>EE</sub> + 0.2 V <sub>EE</sub> + 0.25	
		$V_{CC} = 6.0 \text{ V}, I_{sink} = 5.0 \text{ mA}$ $T_A = 25^{\circ}\text{C}$ $T_A = T_{Low} \text{ to } T_{High}$	-	V <sub>EE</sub> + 0.12	V <sub>EE</sub> + 0.2 V <sub>EE</sub> + 0.25	
t <sub>PHL</sub>	Propagation Delay, High-to-Low	20 mV Overdrive, C <sub>L</sub> = 15 pF	-	1000	_	ns
t <sub>PLH</sub>	Propagation Delay, Low-to-High	20 mV Overdrive, C <sub>L</sub> = 15 pF	-	800	_	ns
t <sub>FALL</sub>	Output Fall Time	$V_{CC} = 6.0 \text{ V}, C_L = 50 \text{ pF}$	-	6.0	-	ns
t <sub>RISE</sub>	Output Rise Time	$V_{CC} = 6.0 \text{ V}, C_L = 50 \text{ pF}$	-	260	-	ns
t <sub>PU</sub>	Powerup Time		_	35	_	μS

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

6. The limits over the extended temperature range are guaranteed by design only.

7. NCS2202: T<sub>Low</sub> = -40°C, T<sub>High</sub> = +105°C; NCV2202: T<sub>Low</sub> = -40°C, T<sub>High</sub> = +125°C

NCS2200A ELECTRICAL CHARACTERISTICS (For all values  $V_{CC} = 0.85 \text{ V}$  to 6.0 V,  $V_{EE} = 0 \text{ V}$ ,  $T_A = 25^{\circ}C$ , unless otherwise noted.) (Note 8)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>HYS</sub>	Input Hysteresis	T <sub>A</sub> = 25°C	2.0	4.5	20	mV
V <sub>IO</sub>	Input Offset Voltage	$V_{CC} = 0.85 \text{ V}$ $T_A = 25^{\circ}\text{C}$ $T_A = -40^{\circ}\text{C} \text{ to } 105^{\circ}\text{C}$	-10 -12	0.5 -	+10 +12	mV
		$V_{CC} = 3.0 \text{ V}$ $T_A = 25^{\circ}\text{C}$ $T_A = -40^{\circ}\text{C} \text{ to } 105^{\circ}\text{C}$	-6.0 -8.0	0.5 -	+6.0 +8.0	
		$V_{CC} = 6.0 \text{ V}$ $T_{A} = 25^{\circ}\text{C}$ $T_{A} = -40^{\circ}\text{C} \text{ to } 105^{\circ}\text{C}$	-5.0 -7.0	0.5 -	+5.0 +7.0	
V <sub>CM</sub>	Common Mode Voltage Range		_	V <sub>EE</sub> to V <sub>CC</sub>	_	V
I <sub>SC</sub>	Output Short–Circuit Sourcing or Sinking	V <sub>out</sub> = GND	_	60	_	mA
CMRR	Common Mode Rejection Ratio	$V_{CM} = V_{CC}$	53	70	-	dB
I <sub>IB</sub>	Input Bias Current		-	1.0	-	рA
PSRR	Power Supply Rejection Ratio	$\Delta V_{S} = 2.575 \text{ V}$	45	80	-	dB
Icc	Supply Current	$V_{CC} = 0.85 \text{ V}$ $T_A = 25^{\circ}\text{C}$ $T_A = -40^{\circ}\text{C} \text{ to } 105^{\circ}\text{C}$	-	7.5 -	15 17	μΑ
		$V_{CC} = 3.0 \text{ V}$ $T_A = 25^{\circ}\text{C}$ $T_A = -40^{\circ}\text{C} \text{ to } 105^{\circ}\text{C}$	-	8.0 -	15 17	
		$V_{CC} = 6.0 \text{ V}$ $T_A = 25^{\circ}\text{C}$ $T_A = -40^{\circ}\text{C} \text{ to } 105^{\circ}\text{C}$	-	9.0 -	15 17	
V <sub>OH</sub>	Output Voltage High	$V_{CC} = 0.85 \text{ V, } I_{source} = 0.5 \text{ mA}$ $T_A = 25^{\circ}\text{C}$ $T_A = -40^{\circ}\text{C to } 105^{\circ}\text{C}$	V <sub>CC</sub> - 0.25 V <sub>CC</sub> - 0.275	V <sub>CC</sub> - 0.10	-	V
		$V_{CC} = 3.0 \text{ V}, I_{source} = 3.0 \text{ mA}$ $T_A = 25^{\circ}\text{C}$ $T_A = -40^{\circ}\text{C} \text{ to } 105^{\circ}\text{C}$	V <sub>CC</sub> - 0.3 V <sub>CC</sub> - 0.35	V <sub>CC</sub> - 0.12	-	
		$V_{CC} = 6.0 \text{ V}, I_{source} = 5.0 \text{ mA}$ $T_A = 25^{\circ}\text{C}$ $T_A = -40^{\circ}\text{C} \text{ to } 105^{\circ}\text{C}$	V <sub>CC</sub> - 0.3 V <sub>CC</sub> - 0.35	V <sub>CC</sub> - 0.12	-	
V <sub>OL</sub>	Output Voltage Low	$V_{CC} = 0.85 \text{ V, } I_{sink} = 0.5 \text{ mA}$ $T_A = 25^{\circ}\text{C}$ $T_A = -40^{\circ}\text{C to } 105^{\circ}\text{C}$	-	V <sub>EE</sub> + 0.10 –	V <sub>EE</sub> + 0.25 V <sub>EE</sub> + 0.275	V
		$V_{CC} = 3.0 \text{ V, } I_{sink} = 3.0 \text{ mA}$ $T_A = 25^{\circ}\text{C}$ $T_A = -40^{\circ}\text{C to } 105^{\circ}\text{C}$	-	V <sub>EE</sub> + 0.12 –	V <sub>EE</sub> + 0.3 V <sub>EE</sub> + 0.35	
		$V_{CC} = 6.0 \text{ V}, I_{sink} = 5.0 \text{ mA}$ $T_A = 25^{\circ}\text{C}$ $T_A = -40^{\circ}\text{C} \text{ to } 105^{\circ}\text{C}$	-	V <sub>EE</sub> + 0.12	V <sub>EE</sub> + 0.3 V <sub>EE</sub> + 0.35	
t <sub>PHL</sub>	Propagation Delay, High-to-Low	20 mV Overdrive, C <sub>L</sub> = 15 pF,	-	625	_	ns
t <sub>PLH</sub>	Propagation Delay, Low-to-High	V <sub>CC</sub> = 2.85 V	-	750	_	ns
t <sub>FALL</sub>	Output Fall Time	$V_{CC} = 6.0 \text{ V}, C_L = 50 \text{ pF (Note 9)}$	-	22	-	ns
t <sub>RISE</sub>	Output Rise Time	$V_{CC} = 6.0 \text{ V}, C_L = 50 \text{ pF (Note 9)}$	_	20	_	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

8. The limits over the extended temperature range are guaranteed by design only.

<sup>9.</sup> Input signal: 1 kHz, squarewave signal with 10 ns edge rate.

 $\textbf{NCS2202A ELECTRICAL CHARACTERISTICS} \text{ (For all values V}_{CC} = 0.85 \text{ V to } 6.0 \text{ V, V}_{EE} = 0 \text{ V, T}_{A} = 25^{\circ}\text{C}, \text{ R}_{pullup} = 10 \text{ k}\Omega, \text{ R}_{p$ unless otherwise noted.) (Note 10)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{HYS}$	Input Hysteresis	T <sub>A</sub> = 25°C	2.0	4.5	20	mV
V <sub>IO</sub>	Input Offset Voltage	V <sub>CC</sub> = 0.85 V				mV
	-	T <sub>A</sub> = 25°C	-10	0.3	+10	
		$T_A = -40^{\circ}C \text{ to } 105^{\circ}C$	–12	_	+12	
		$V_{CC} = 3.0 \text{ V}$				
		T <sub>A</sub> = 25°C	-6.0	0.4	+6.0	
		$T_A = -40^{\circ}\text{C to } 105^{\circ}\text{C}$	-8.0	_	+8.0	4
		V <sub>CC</sub> = 6.0 V	5.0	0.4	.5.0	
		$T_A = 25^{\circ}C$ $T_A = -40^{\circ}C$ to 105°C	-5.0 -7.0	0.4	+5.0 +7.0	
V <sub>CM</sub>	Common Mode Voltage Range	1 <sub>A</sub> = 40 0 to 100 0	-	V <sub>EE</sub> to V <sub>CC</sub>	-	V
I <sub>SC</sub>	Output Short–Circuit Sourcing or	V <sub>out</sub> = GND	_	60	_	mA
isc	Sinking	Vout = SIVE			_	IIIA
CMRR	Common Mode Rejection Ratio	V <sub>CM</sub> = V <sub>CC</sub>	53	80	_	dB
I <sub>IB</sub>	Input Bias Current	S 90	_	1.0	_	pА
PSRR	Power Supply Rejection Ratio	ΔV <sub>S</sub> = 2.575 V	45	80	_	dB
Icc	Supply Current	V <sub>CC</sub> = 0.85 V	<b>†</b>			μА
00		T <sub>A</sub> = 25°C	_	7.5	15	
		$T_A = -40^{\circ}C$ to $105^{\circ}C$		_	17	
		V <sub>CC</sub> = 3.0 V				1
		T <sub>A</sub> = 25°C	_	8.0	15	
		$T_A = -40^{\circ}C \text{ to } 105^{\circ}C$		_	17	1
		V <sub>CC</sub> = 6.0 V			4-	
		$T_A = 25^{\circ}C$	_	9.0	15	
\/	Output Valtage Laur	$T_A = -40^{\circ}\text{C to } 105^{\circ}\text{C}$		_	17	V
$V_{OL}$	Output Voltage Low	$V_{CC} = 0.85 \text{ V}, I_{sink} = 0.5 \text{ mA}$ $T_{A} = 25^{\circ}\text{C}$	_	V <sub>EE</sub> + 0.14	V <sub>EE</sub> + 0.25	V
		$T_A = 25 \text{ G}$ $T_A = -40^{\circ}\text{C} \text{ to } 105^{\circ}\text{C}$		VEE 1 0.14	V <sub>EE</sub> + 0.275	
		V <sub>CC</sub> = 3.0 V, I <sub>sink</sub> = 3.0 mA			LL ·	1
		T <sub>A</sub> = 25°C	_	V <sub>EE</sub> + 0.18	V <sub>EE</sub> + 0.3	
		$T_A = -40^{\circ}\text{C} \text{ to } 105^{\circ}\text{C}$			V <sub>EE</sub> + 0.35	
		V <sub>CC</sub> = 6.0 V, I <sub>sink</sub> = 5.0 mA				1
		$T_A = 25^{\circ}C$	_	$V_{EE} + 0.20$	$V_{EE} + 0.3$	
		$T_A = -40^{\circ}C$ to $105^{\circ}C$		_	V <sub>EE</sub> + 0.35	
$t_{PHL}$	Propagation Delay – High to Low	20 mV Overdrive, C <sub>L</sub> = 15 pF,	_	580	-	ns
		V <sub>CC</sub> = 2.85 V				
		50 mV Overdrive, $C_L = 15 \text{ pF}$ ,	_	350	_	
		V <sub>CC</sub> = 2.85 V		222		1
		100 mV Overdrive, C <sub>L</sub> = 15 pF,	_	220	_	
1	Draw a matical Dalace I accept a High	V <sub>CC</sub> = 2.85 V		FFO		
t <sub>PLH</sub>	Propagation Delay – Low to High	20 mV Overdrive, $C_L = 15 \text{ pF}$ , $V_{CC} = 2.85 \text{ V}$	_	550	_	ns
		$\frac{\sqrt{CC} - 2.03 \text{ V}}{50 \text{ mV Overdrive, C}_{L} = 15 \text{ pF},}$	_	400	_	-
		V <sub>CC</sub> = 2.85 V	-	400	_	
		100 mV Overdrive, C <sub>L</sub> = 15 pF,	_	340	_	1
		$V_{CC} = 2.85 \text{ V}$		3-0		
t <sub>FALL</sub>	Output Fall Time	V <sub>CC</sub> = 6.0 V, C <sub>L</sub> = 50 pF (Note	_	5.0	_	ns
1 ALL	,	11)				"
t <sub>RISE</sub>	Output Rise Time	V <sub>CC</sub> = 6.0 V, C <sub>L</sub> = 50 pF (Note	_	235	_	ns
I NIOL	•	11)	I		I	1

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

10. The limits over the extended temperature range are guaranteed by design only.

<sup>11.</sup> Input signal: 1 kHz, squarewave signal with 10 ns edge rate.

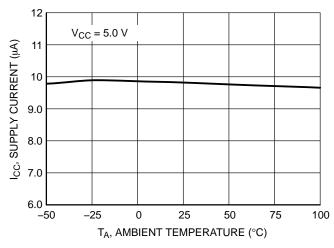


Figure 1. NCS2200 Series Supply Current versus Temperature

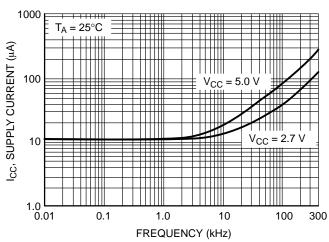


Figure 2. NCS2200 Series Supply Current versus Output Transition Frequency

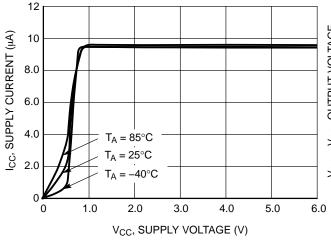


Figure 3. NCS2200 Series Supply Current versus Supply Voltage

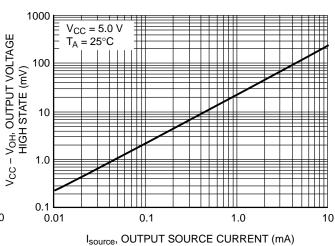


Figure 4. NCS2200 Output Voltage High State versus Output Source Current

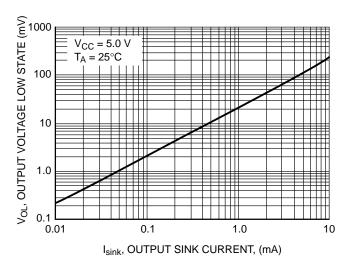


Figure 5. NCS2200 Series Output Voltage Low State versus Output Sink Current

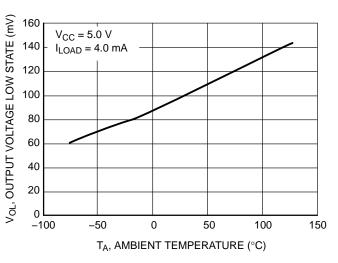


Figure 6. NCS2200 Series Output Voltage Low State versus Temperature

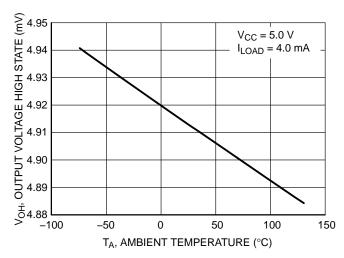


Figure 7. NCS2200 Series Output Voltage High State versus Temperature

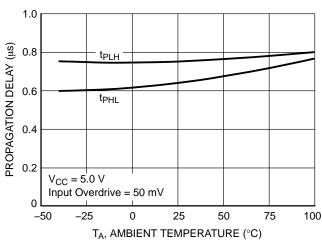


Figure 8. NCS2200 Series Propagation Delay versus Temperature

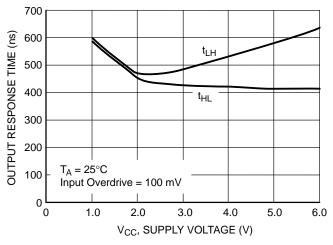


Figure 9. NCS2200 Series Output Response Time versus Supply Voltage

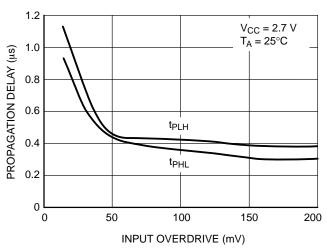


Figure 10. NCS2200 Series Propagation Delay versus Input Overdrive

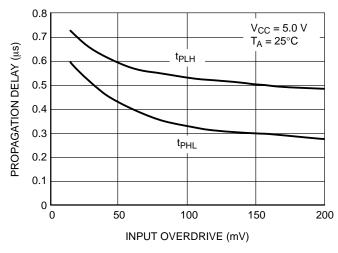


Figure 11. NCS2200 Series Propagation Delay versus Input Overdrive

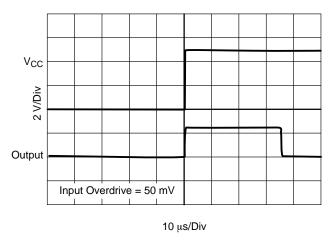


Figure 12. NCS2200 Series Powerup Delay

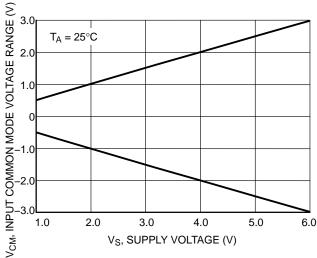


Figure 13. NCS2200 Series Input Common Mode Voltage Range versus Supply Voltage

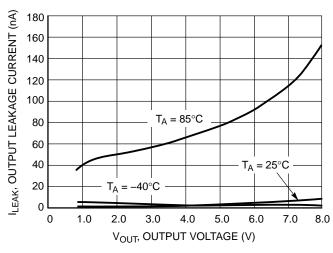


Figure 14. NCS2202 Output Leakage Current versus Output Voltage

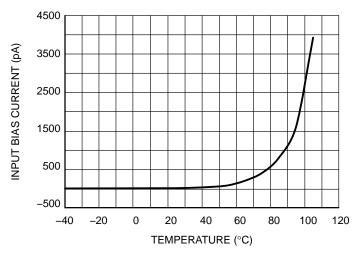


Figure 15. Input Bias Current versus Temperature

#### **OPERATING DESCRIPTION**

The NCS2200 Series is an industry first sub—one volt, low power comparator family. This series is designed for rail—to—rail input and output performance. These devices consume only 10 μA of supply current while achieving a typical propagation delay of 1.1 μs at a 20 mV input overdrive. Figures 10 and 11 show propagation delay with various input overdrives. This comparator family is guaranteed to operate at a low voltage of 0.85 V up to 6.0 V. This is accomplished by the use of a modified analog CMOS process that implements depletion MOSFET devices. The common—mode input voltage range extends 0.1 V beyond the upper and lower rail without phase inversion or other adverse effects. This series is available in the SOT–23–5

package. Additionally, the NCS2200 device is available in the tiny DFN 2x2.2 package and the SC70–5 package. NCS2200A is available in UDFN package.

## **Output Stage**

The NCS2200 has a complementary P and N Channel output stage that has capability of driving a rail-to-rail output swing with a load ranging up to 5.0 mA. It is designed such that shoot-through current is minimized while switching. This feature eliminates the need for bypass capacitors under most circumstances.

The NCS2202 has an open drain N-channel output stage that can be pulled up to 6.0 V (max) with an external resistor. This facilitates mixed voltage system applications.

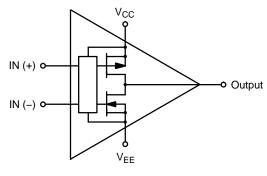


Figure 16. NCS2200/NCS2200A Complementary Output Configuration

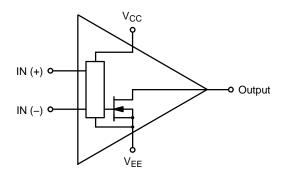
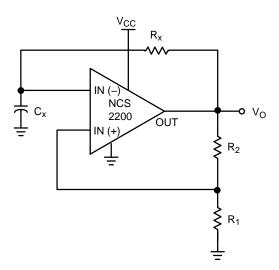


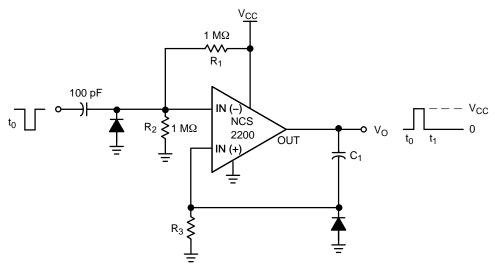
Figure 17. NCS2202/NCS2202A Open Drain
Output Configuration



The oscillation frequency can be programmed as follows:

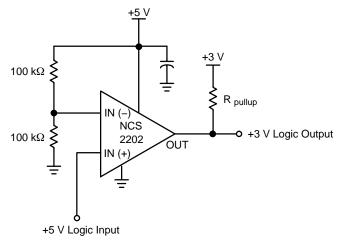
$$f = \frac{1}{T} = \frac{1}{2.2 \; R_X C_X}$$

Figure 18. Schmitt Trigger Oscillator



The resistor divider  $R_1$  and  $R_2$  can be used to set the magnitude of the input pulse. The pulse width is set by adjusting  $C_1$  and  $R_3$ .

Figure 19. One-Shot Multivibrator



This circuit converts 5 V logic to 3 V logic. Using the NCS2202/A allows for full 5 V logic swing without creating overvoltage on the 3 V logic input.

Figure 20. Logic Level Translator

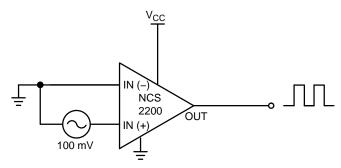


Figure 21. Zero-Crossing Detector

## **ORDERING INFORMATION**

Device	Pinout Style	Output Type	Package	Shipping <sup>†</sup>
NCS2200AMUT1G	N/A	Complementary	UDFN (Pb-Free)	3000 / Tape & Reel
NCS2200SN1T1G	1	Complementary	SOT-23-5 (TSOP-5) (Pb-Free)	3000 / Tape & Reel
NCV2200SN1T1G*	1	Complementary	SOT-23-5 (TSOP-5) (Pb-Free)	3000 / Tape & Reel
NCS2200SN2T1G	2	Complementary	SOT-23-5 (TSOP-5) (Pb-Free)	3000 / Tape & Reel
NCV2200SN2T1G*	2	Complementary	SOT-23-5 (TSOP-5) (Pb-Free)	3000 / Tape & Reel
NCS2200SQ2T2G	2	Complementary	SC70-5 (Pb-Free)	3000 / Tape & Reel
NCV2200SQ2T2G*	2	Complementary	SC70-5 (Pb-Free)	3000 / Tape & Reel
NCS2200SQLT1G	N/A	Complementary	DFN, 2x2.2 (Pb-Free)	3000 / Tape & Reel
NCS2202SN1T1G	1	Open Drain	SOT-23-5 (TSOP-5) (Pb-Free)	3000 / Tape & Reel
NCS2202SN2T1G	2	Open Drain	SOT-23-5 (TSOP-5) (Pb-Free)	3000 / Tape & Reel
NCV2202SN2T1G*	2	Open Drain	SOT-23-5 (TSOP-5) (Pb-Free)	3000 / Tape & Reel
NCS2202SQ1T2G	1	Open Drain	SC70-5 (Pb-Free)	3000 / Tape & Reel
NCS2202SQ2T2G	2	Open Drain	SC70-5 (Pb-Free)	3000 / Tape & Reel
NCS2202AMUTBG	N/A	Open Drain	UDFN (Pb-Free)	3000 / Tape & Reel

This device contains 93 active transistors.

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

<sup>\*</sup>NCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

#### **MARKING DIAGRAMS**

SOT-23-5 (TSOP-5) SN SUFFIX CASE 483



x = I for NCS2200SN1T1 J for NCS2200SN2T1 M for NCS2202SN1T1 N for NCS2202SN2T1

A = Assembly Location

Y = Year W = Work Week ■ = Pb-Free Package

(Note: Microdot may be in either location)

DFN6 2x2.2 SQL SUFFIX CASE 488



CB = Specific Device Code

M = Date Code\*

= Pb–Free Package

(Note: Microdot may be in either location)

\*Date Code overbar and underbar may vary depending upon manufacturing location.

SC70-5 SQ SUFFIX CASE 419A



CBx = Specific Device Code x = A for NCS2200SQ2T2 D for NCS2202SQ1T2G E for NCS2202SQ2T2G

M = Date Code\*
■ Pb–Free Package

(Note: Microdot may be in either location)
\*Date Code orientation, position, and underbar
may vary depending upon manufacturing location.

UDFN6 1.2x1.0 MU SUFFIX CASE 517AA



(Top View)

x S for Specific Device Code

V for NCS2202A (V with 180° Rotation)

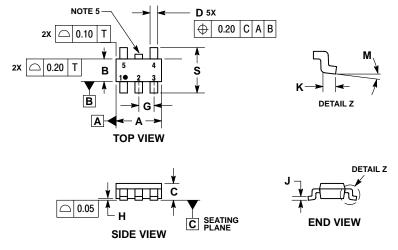
M = Date Code

= Pb–Free Package

## **PACKAGE DIMENSIONS**

### SOT-23-5 / TSOP-5 / SC59-5 **SN SUFFIX** CASE 483-02

ISSUE K

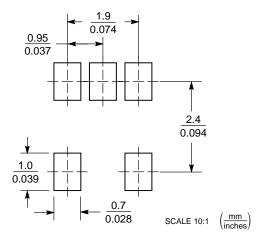


- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.

- CONTROLLING DIMENSION: MILLIMETERS.
  MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH
  THICKNESS. MINIMUM LEAD THICKNESS IS THE
  MINIMUM THICKNESS OF BASE MATERIAL.
  DIMENSIONS A AND B DO NOT INCLUDE MOLD
  FLASH, PROTRUSIONS, OR GATE BURRS. MOLD
  FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT
  EXCEED 0.15 PER SIDE. DIMENSION A.
  OPTIONAL CONSTRUCTION: AN ADDITIONAL
  TRIMMED LEAD IS ALLOWED IN THIS LOCATION.
  TRIMMED LEAD NOT TO EXTEND MORE THAN 0.2
  FROM BODY.

	MILLIMETERS				
DIM	MIN	MAX			
Α	3.00	BSC			
В	1.50	BSC			
C	0.90	1.10			
D	0.25 0.5				
G	0.95	BSC			
Н	0.01	0.10			
J	0.10	0.26			
K	0.20 0.60				
М	0° 10°				
S	2.50	3.00			

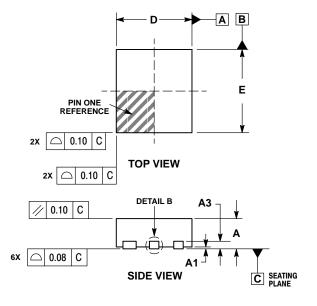
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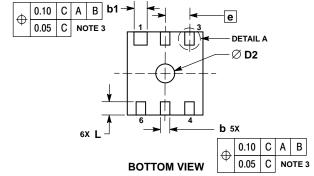


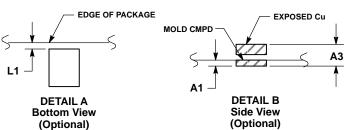
<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### **PACKAGE DIMENSIONS**

DFN6, 2x2.2 **SQL SUFFIX** CASE 488-03 **ISSUE G** 



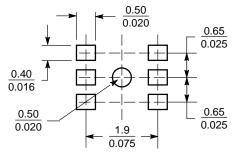




- NOTES:
  1. DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSION & APPLIES TO PLATED
  TERMINAL AND IS MEASURED BETWEEN
- 1EHMINAL AND IS MEASURED BE I WEEN
  0.25 AND 0.30mm FROM TERMINAL
  COPLANARITY APPLIES TO THE EXPOSED
  PAD AS WELL AS THE TERMINALS.
  TERMINAL b MAY HAVE MOLD COMPOUND
  MATERIAL ALONG SIDE EDGE.
- DETAILS A AND B SHOW OPTIONAL VIEWS FOR END OF TERMINAL LEAD AT EDGE OF PACKAGE AND SIDE EDGE OF PACKAGE.

	MILLIMETERS						
DIM	MIN	MIN NOM MAX					
Α	0.80	0.90	1.00				
A1	0.00	0.03	0.05				
A3		0.20 REF					
b	0.20	0.25	0.30				
b1	0.30	0.35	0.40				
D		2.00 BSC					
D2	0.40	0.50	0.60				
E	2.20 BSC						
е	0.65 BSC						
L	0.30	0.35	0.40				
L1	0.00	0.05	0.10				

#### **SOLDERING FOOTPRINT\***

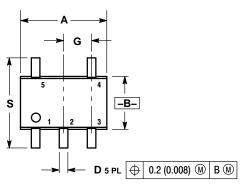


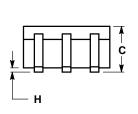
SCALE 10:1

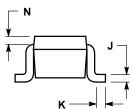
\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## **PACKAGE DIMENSIONS**

## SC-88A (SC-70-5/SOT-353) SQ SUFFIX CASE 419A-02 **ISSUE L**



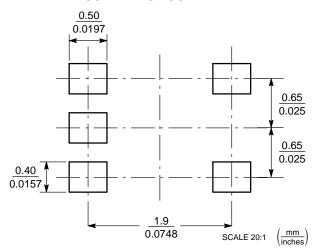




- NOTES:
  1. DIMENSIONING AND TOLERANCING
- PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH. 419A-01 OBSOLETE. NEW STANDARD 419A-02.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.071	0.087	1.80	2.20
В	0.045	0.053	1.15	1.35
С	0.031	0.043	0.80	1.10
D	0.004	0.012	0.10	0.30
G	0.026	BSC	0.65 BSC	
Н		0.004		0.10
J	0.004	0.010	0.10	0.25
K	0.004	0.012	0.10	0.30
N	0.008	REF	0.20 REF	
S	0.079	0.087	2.00 2.2	

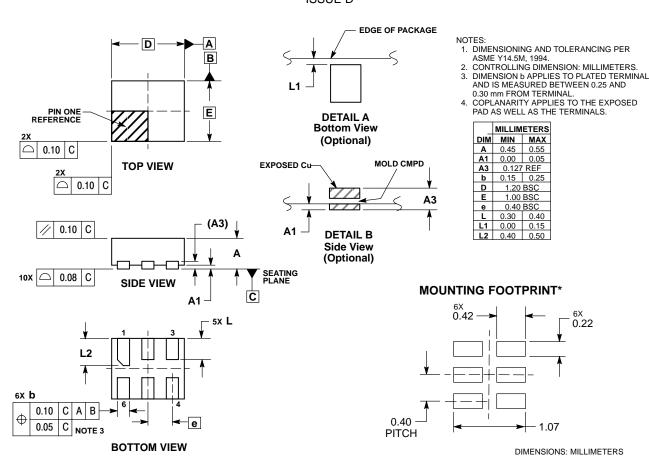
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\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### PACKAGE DIMENSIONS

### UDFN6, 1.2x1.0, 0.4P CASE 517AA ISSUE D



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